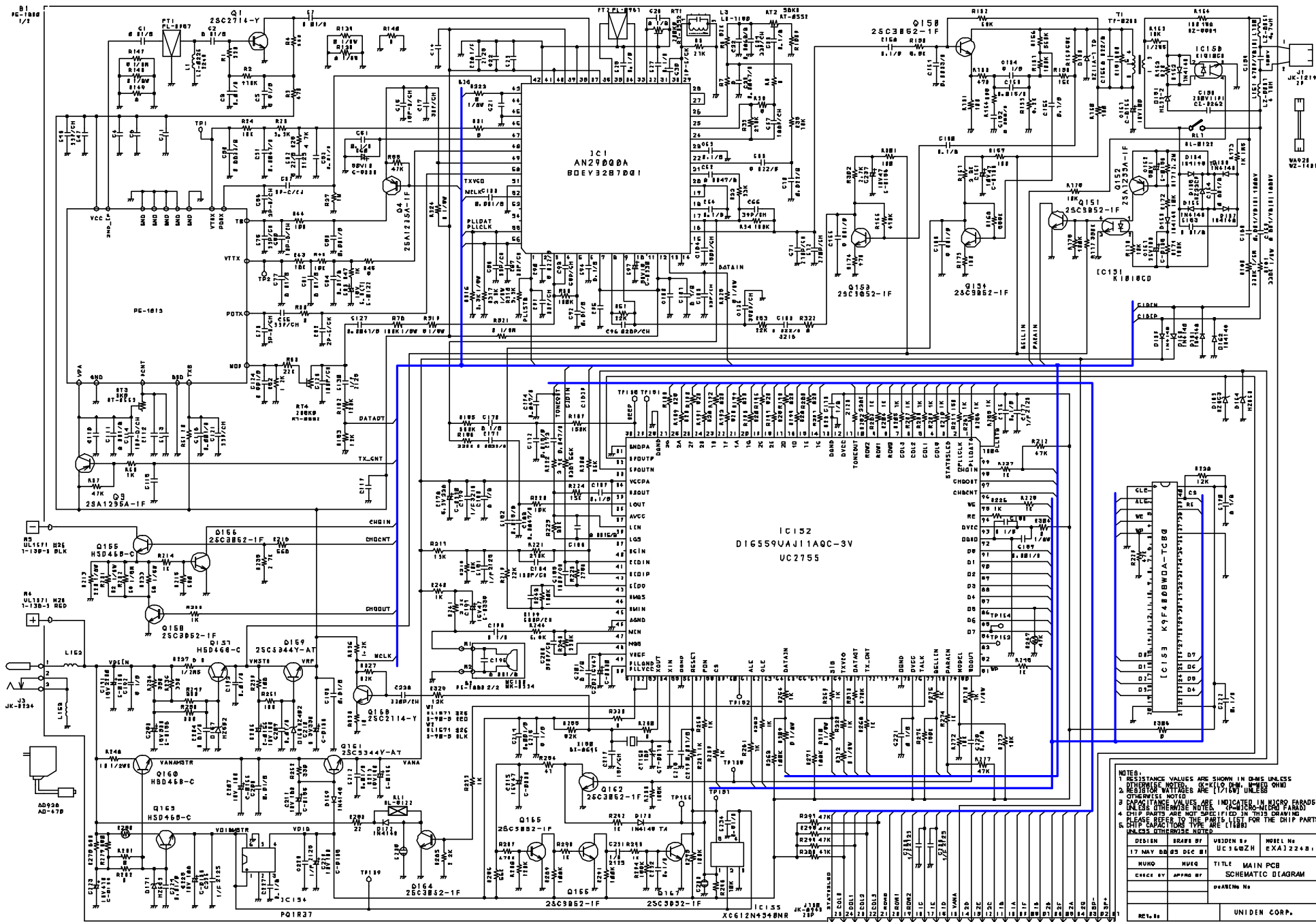
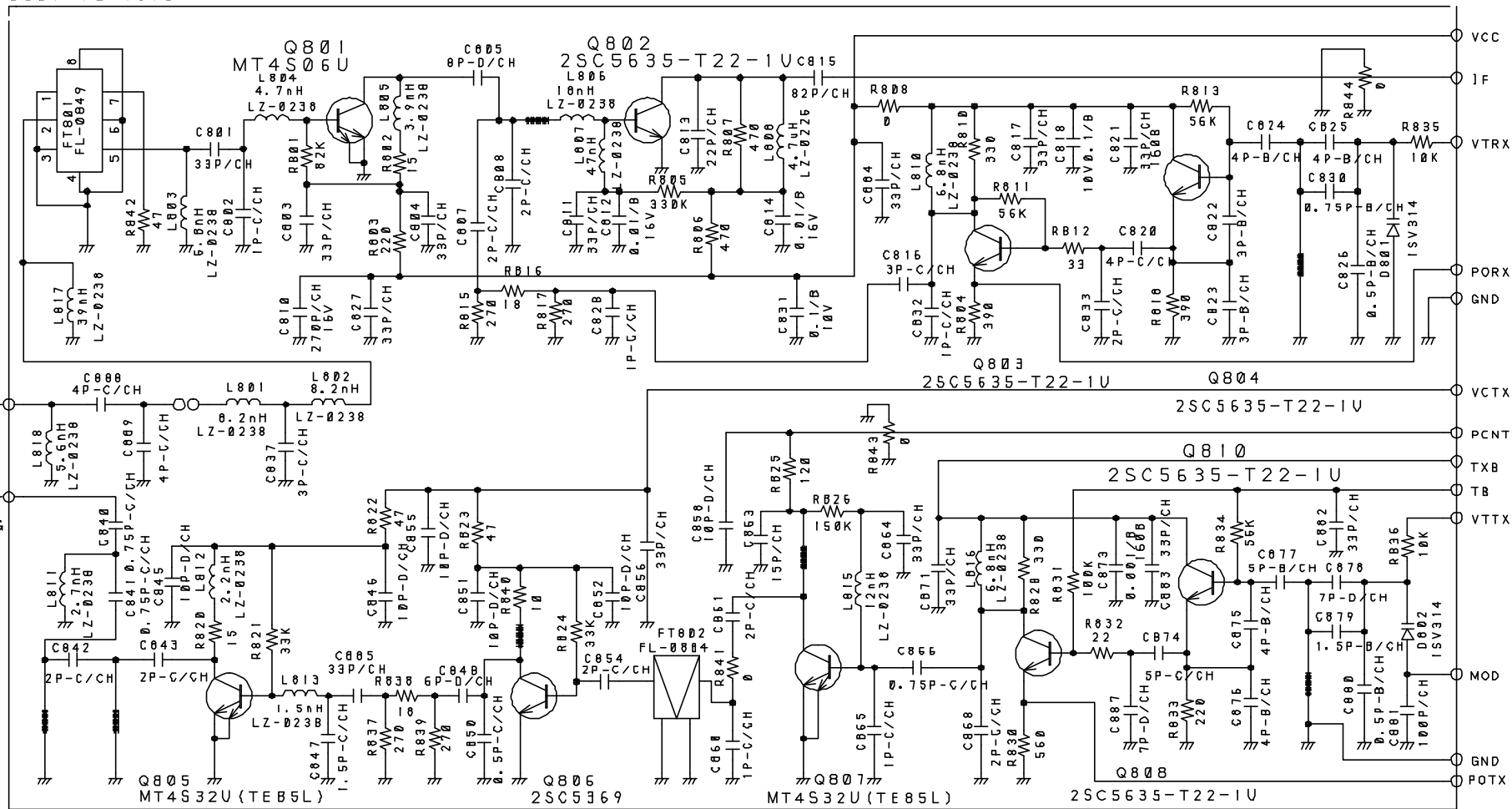


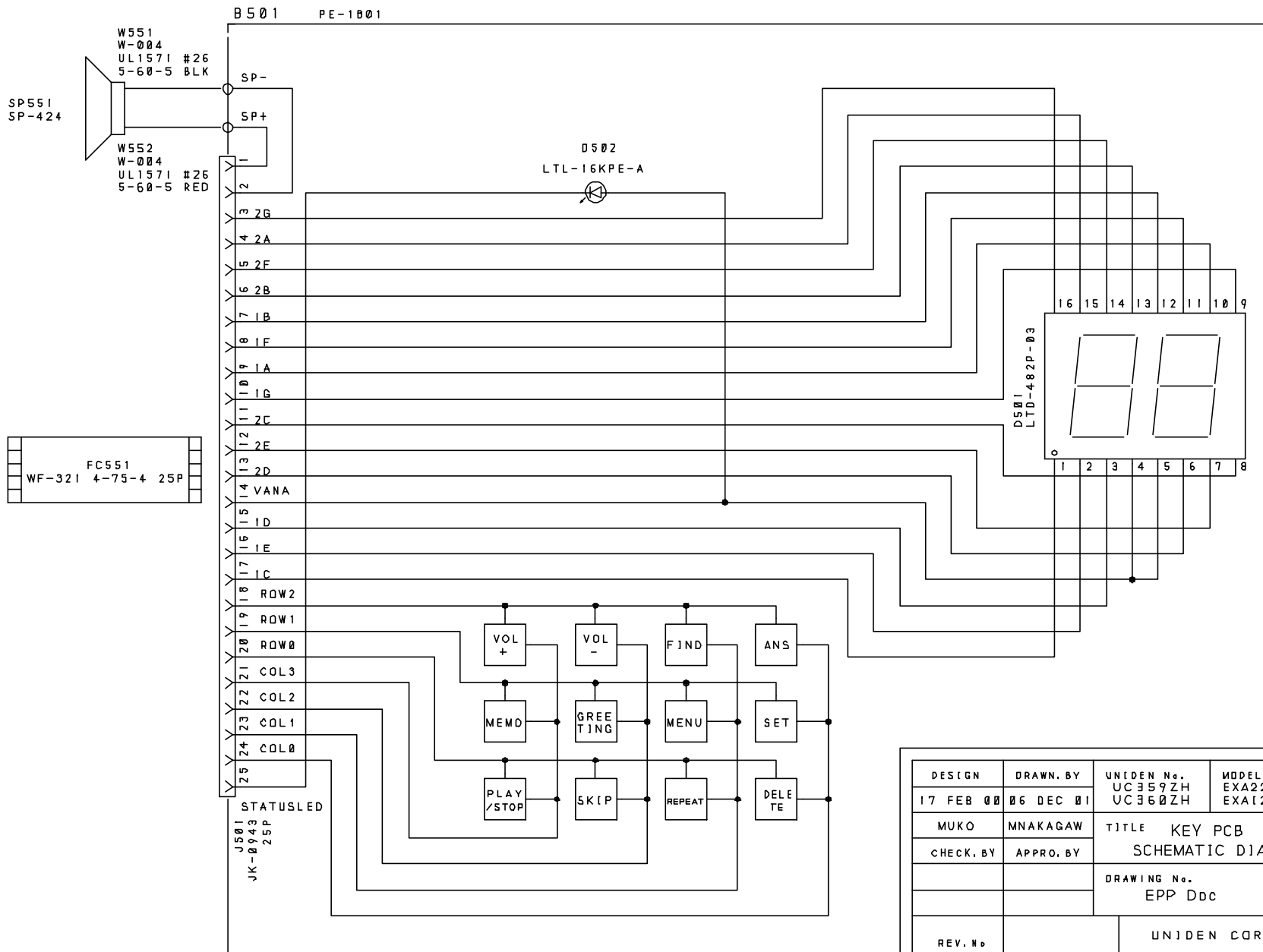


NOTES:			
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED.			
2. CAPACITANCE VALUES ARE IN PICO UNLESS OTHERWISE NOTED.			
3. RESISTANCE VALUES ARE INDICATED IN MICRO FARDS UNLESS OTHERWISE NOTED.			
4. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING UNLESS SPECIFICATION TYPE ARE (1188)			
5. CHIPS, CAPACITORS ARE (1188)			
6. CHIPS, RESISTORS ARE (1188)			
DESIGN	DATE	VERSION	MODEL
17 MAY 88	25 DEC 81	5 C 6 WZH	EXA12248:
MUMD	MUSG	TITLE MAIN PCB	
CHECK BY	APPROV BY	SCHEMATIC DIAGRAM	
DRAWING No			
REL. to		UNIDEN CORP.	



1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILLO OHM, M=MEG OHM)
2. RESISTOR WATTAGES ARE [1/16W (1005)] UNLESS OTHERWISE NOTED.
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
4. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.
5. CHIP CAPACITORS TYPE ARE [1005] UNLESS OTHERWISE NOTED.

DESIGN	DRAWN BY	UNIDEN No.	MODEL No.
May/14/01	01/12/05	UC360ZH	EXA12248i
YU1	SUWA	TITLE BASE RF	
CHECK BY	APPRO. BY	SCHEMATIC DIAGRAM	
		DRAWING No	
REV No		UNIDEN CORP.	



DESIGN	DRAWN BY	UNIDEN No.	MODEL No.
17 FEB 00	06 DEC 01	UC359ZH UC360ZH	EXA2245 EXA122401
MUKO	MNAKAGAW	TITLE KEY PCB SCHEMATIC DIAGRAM	
CHECK BY	APPRO BY		
		DRAWING No. EPP Ddc	
REV. No.		UNIDEN CORP	

1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MEG OHM)
2. RESISTOR WATTAGES ARE [1/16W] UNLESS OTHERWISE NOTED.
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED (P=MICRO-MICRO FARAD)
4. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.
5. CHIP CAPACITORS TYPE ARE [1608] UNLESS OTHERWISE NOTED

DESIGN		DRAWN BY		UNIDEN No.		MODEL No.	
01/05/2		01/9/13		UC350ZH		EXA1224B	
OHARA		NKZT		TITLE PORTABLE MAIN SCHEMATIC DIAGRAM			
CHECK BY		APPRO BY					
				DRAWING No			
REV. No				UNIDEN CORP			

